

# Specification of MEMS Microphone

(RoHS Compliance & Halogen-free)

Customer Name:

Customer Model:

Goermicro Model: S15OT421-017



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# Restricted

# 1 Security Warning

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# 2 Publication History

Version	Date	Description	Author	Approved
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#### 1 Introduction:

MEMS MIC which is able to endure reflow temperature up to  $260^{\circ}$ C for 50 seconds can be used in SMT process. It is widely used in telecommunication and electronics device such as mobile phone, laptop computers, and other portable electronic devices etc.

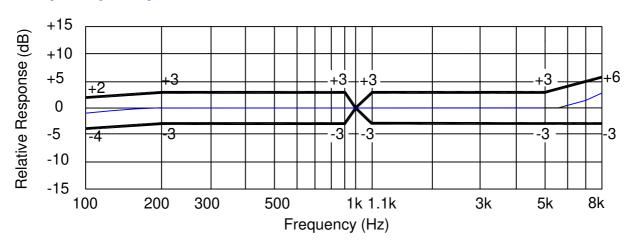
# 2 Test Condition (Vs=2.7V,L=50cm)

StandardConditions (As IEC 60268-4)	Temperature	Humidity	Air pressure
Environment Conditions	+15℃~+35℃	25%RH~75%RH	86kPa $\sim$ 106kPa
Basic Test Conditions	+20±2℃	60%RH~70%RH	86kPa∼106kPa

#### 3 Electrical Characteristics

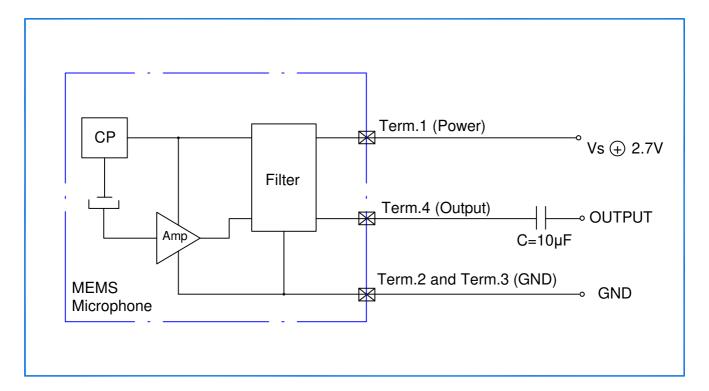
Item	Symbol	Test Conditions	Min	Тур	Max	Unit
Sensitivity	S	f=1kHz, Pin=1Pa	-43	-42	-41	dB
Output Impedance	Zout	f=1kHz, Pin=1Pa			400	Ω
Directivity	D(θ)			Omnidir	ectional	
Current Consumption	I				150	μΑ
S/N Ratio	S/N(A)	f=1kHz, Pin=1Pa A-Weighted	58	59		dB
Decreasing Voltage Characteristic	ΔS	f=1kHz, Pin=1Pa Vs=3.62.0V		No C	hange	
Operating Voltage Range	Vs		2.0		3.6	٧
Total Harmonic Distortion	THD	110dB SPL@ f=1kHz			1	%
Acoustic Overload Point	AOP	10% THD @1kHz		130		dBSPL

# **4 Frequency Response Curve Limits**

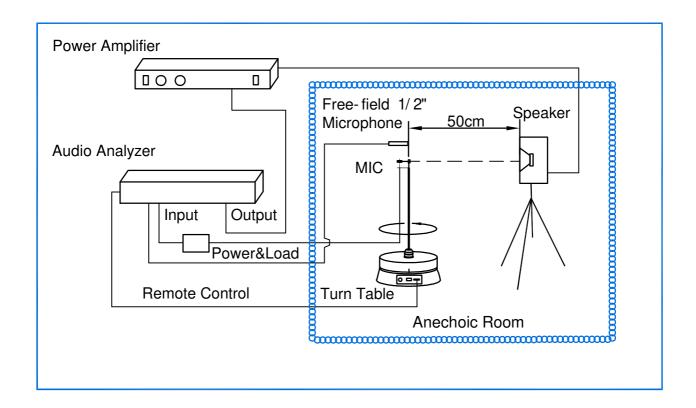




#### **5 Measurement Circuit**



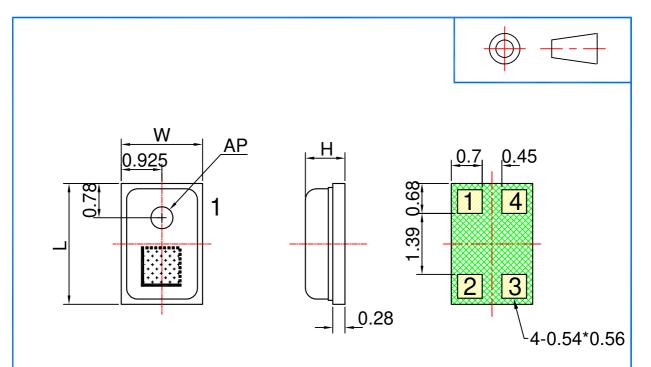
# 6 Test Setup Drawing





#### 7 Mechanical Characteristics

## 7.1 Appearance Drawing (Unit: mm)



Top View

# **Bottom View**

Pin Output				
Pin# Function				
1	Power			
2	GND			
3	GND			
4	Output			

Item	Dimension	Tol.(±)	Units
Length	2.75	0.1	mm
Width	1.85	0.1	mm
Height	0.95	0.1	mm
AP (Acoustic port)	0.5	0.1	mm

Note: 1. Tolerance ±0.10mm unless otherwise specified.

2. Identification Number Convention: Job Identification Number.

Identification Number



#### 7.2 Weight

The weight of the MIC is Less than 0.04g.



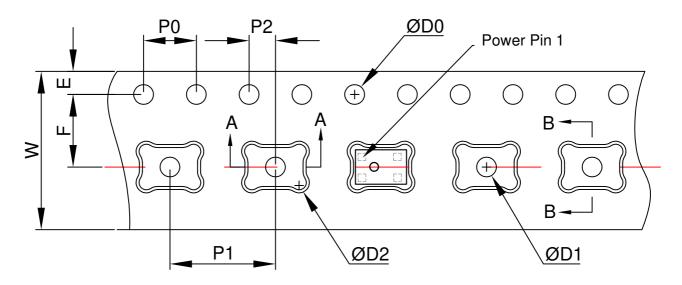
# 8 Reliability

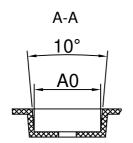
8.1 Vibration Test	To be no interference in operation after vibrations, 4 cycles, from 20 to 2,000Hz in each direction(X,Y,Z), 48 minutes, using peak acceleration of 20g, sensitivity should vary within $\pm 3$ dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at $\pm 15^{\circ}$ C $\pm 435^{\circ}$ C, R.H 25% $\pm 75^{\circ}$ C)
8.2 Drop Test	To be no interference in operation after dropped to 1.0cm steel plate 18 times from 1.5 meter height, sensitivity should vary within $\pm 3$ dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at $\pm 15^{\circ}$ C $\rightarrow \pm 35^{\circ}$ C, R.H 25% $\rightarrow \pm 75^{\circ}$ C)
8.3 Temperature Test	a) After exposure at +125°C for 200 hours, sensitivity should vary within ±3dB from initial sensitivity.  (The measurement to be done after 2 hours of conditioning at +15°C~+35°C, R.H 25%~75%)  b) After exposure at -40°C for 200 hours, sensitivity should vary within ±3dB from initial sensitivity.  (The measurement to be done after 2 hours of conditioning at +15°C~+35°C, R.H 25%~75%)
8.4 Humidity Test	After exposure at +85°C and 85% relative humidity for 200 hours, sensitivity should vary within ±3dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at +15°C $\sim$ +35°C, R.H 25% $\sim$ 75%)
8.5 Mechanical Shock Test	Then subject samples to three one-half sine shock pulses (3000 g for 0.3 milliseconds) in each direction (for six axes in total) along each of the three mutually perpendicular axes for a total of 18 shocks, sensitivity should vary within ±3dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at +15 $^{\circ}$ C $^{\circ}$ +35 $^{\circ}$ C, R.H 25% $^{\circ}$ 75%)
8.6 Thermal Shock Test	After exposure at -40°C for 30 minutes, at +125°C for 30 minutes (change time 20 seconds) 5 cycles, sensitivity should vary within ±3dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at +15°C $\sim$ +35°C, R.H 25% $\sim$ 75%)
8.7 Reflow Test	Adopt the reflow curve of item 12.3, after five reflows, sensitivity should vary within $\pm 2dB$ from initial sensitivity. (The measurement to be done after 2 hours of conditioning at $\pm 15^{\circ}$ C $\rightarrow \pm 35^{\circ}$ C, R.H 25% $\rightarrow \pm 75^{\circ}$ C)
8.8 Electrostatic Discharge Test	Under C=150pF, R=330ohm. Tested to ±8KV contact to the case and tested to ±2kV contact to I/O terminals.10 times. Grounding. Sensitivity should vary within ±2dB from initial sensitivity.

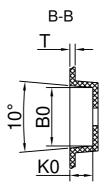


# 9 Package

## 9.1 Tape Specification







#### The Dimensions as Follows:

ITEM	W	E	F	ØD0	ØD1
DIM(mm)	12.0±0.30	1.75±0.10	5.5±0.05	1.50+0.10	1.00 <sup>+0.10</sup>
ITEM	P0	10P0	P1	A0	В0
DIM(mm)	4.00±0.10	40.00±0.20	8.00±0.10	3.00±0.05	2.05±0.05
ITEM	K0	P2	Т	ØD2	
DIM(mm)	1.10±0.10	2.00±0.1	0.30±0.05	0.50±0.10	

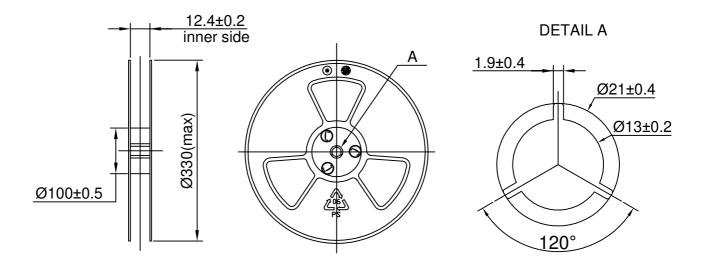


#### 9.2 Reel Dimension

7" reel for sample stage

13" reel will be provided for the mass production stage

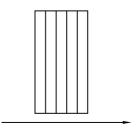
The following is 13" reel dimensions (unit:mm)

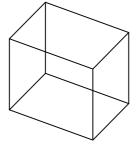


#### 9.3 The Content of Box(13" reel)

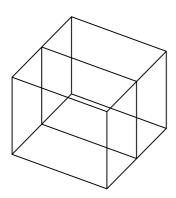


Packing (5,500PCS)

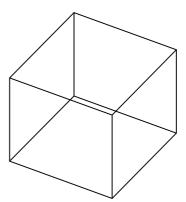




Inner Box(27,500PCS) (340mm×135mm×355mm)



Two Inner Box(55,000PCS)



Outer Box(55,000PCS) (370mm×300mm×390mm)



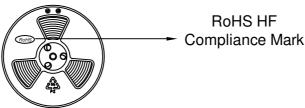
#### 9.4 Packing Explain





The Content Includes: Product type, Lot, Customer P/N; and other essential information such as Quantity, Date etc.

#### 9.4.2 The RoHS Label



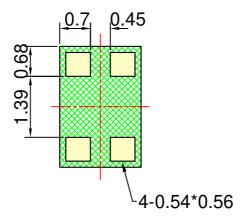
# 10 Storage and Transportation

- 10.1 Keep MEMS MIC in warehouse with less than 75% humidity and without sudden temperature change, acid air, any other harmful air or strong magnetic field. Recommend storage period no more than 1 year and floor life(out of bag) at factory no more than 4 weeks.
- 10.2 The MEMS MIC with normal pack can be transported by ordinary conveyances. Please protect products against moist, shock, sunburn and pressure during transportation.
- 10.3 Storage Temperature Range:  $-40^{\circ}\text{C} \sim +70^{\circ}\text{C}$  (Microphone units with package)
- 10.4 Operating Temperature Range: -40°C ~+100°C

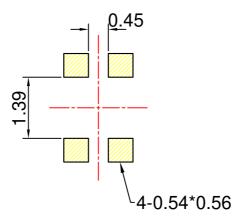


## 11 Land Pattern Recommendation

# 11.1 The Pattern of MIC Pad(Unit:mm)



## 11.2 Recommended Soldering Surface Land Pattern



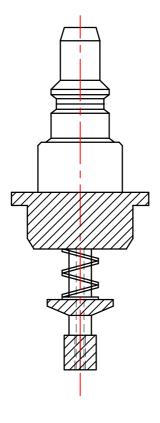


# 12 Soldering Recommendation

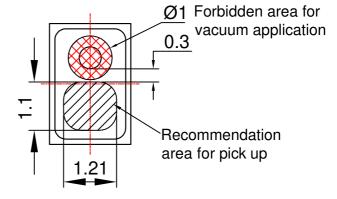
### 12.1 Soldering Machine Condition

Temperature Control	8 zones
Heater Type	Hot Air
Solder Type	Lead-free

## 12.2 The Drawing and Dimension of Nozzle



Nozzle Diameter: 0.8mm

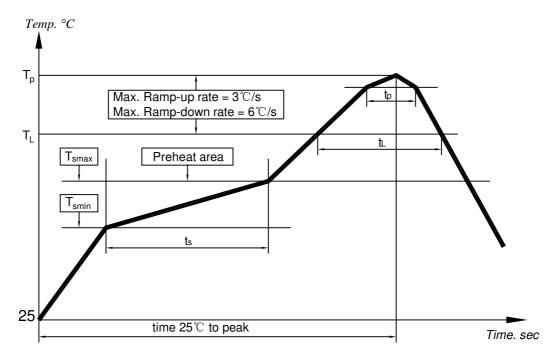




Please don't vacuum over the acoustic port directly. The recommendation is for reference.



#### 12.3 Reflow Profile



## **Key Features of The Profile:**

Average Ramp-up rate(T <sub>smax</sub> to T <sub>p</sub> )	3℃/s max.
Preheat : Temperature Min( $T_{smin}$ ) Temperature Max( $T_{smax}$ ) Time( $T_{smin}$ to $T_{smax}$ )( $t_s$ )	150℃ 200℃ 60~180s
Time maintained above : $Tempreature(T_L) \\ Time(t_L)$	217℃ 60~150s
Peak Temperature(T <sub>p</sub> )	260℃
Time within $5^{\circ}\!$	30~40s
Ramp-down rate(T <sub>p</sub> to T <sub>smax</sub> )	6°C/s max
Time 25℃ to Peak Temperature	8min max

When MEMS MIC is soldered on PCB, the reflow profile is set according to solder paste and the thickness of PCB etc.



#### 13 Cautions

#### 13.1 Board Wash Restrictions

It is very important not to wash the PCBA after reflow process, otherwise this could damage the microphone.

#### 13.2 Nozzle Restrictions

It is very important not to be put a nozzle over the acoustic hole of the microphone, otherwise this could damage the microphone.

#### 13.3 Blowing Restrictions

It is very important not to blow the acoustic port of the microphone directly, otherwise this could damage the microphone.

#### 13.4 Ultrasonic Restrictions

It is very important not to use ultrasonic process. otherwise this could damage the microphone.

#### 13.5 Case Adaption to Pressure Restrictions

It is very important not to press the case with a force larger than 2.5kgf, otherwise this would damage the microphone.

# 14 Output Inspection Standard

Output inspection standard is executed according to <<ISO2859-1:1999>>.